

LIGHT ELECTRONICS CO., LTD. Part No. LG-355PT2C94F-928 4 of 9 Page





Photo Transistor Diode Specification

●Commodity: Photo Transistor

●Ic(on) Bin Code (V_{CE}=5V, Ee=1mW/cm², p=940nm)

| BIN CODE | Min. (mA) | Max. (mA) |
|----------|-----------|-----------|
| X2 | 3.7 | 4.4 |
| Х3 | 4.4 | 5.3 |

| Part No. | LG-355PT2C94F-928 | Page | 5 of 9 |
|----------|-------------------|------|--------|
|----------|-------------------|------|--------|

LIGHT ELECTRONICS CO., LTD.



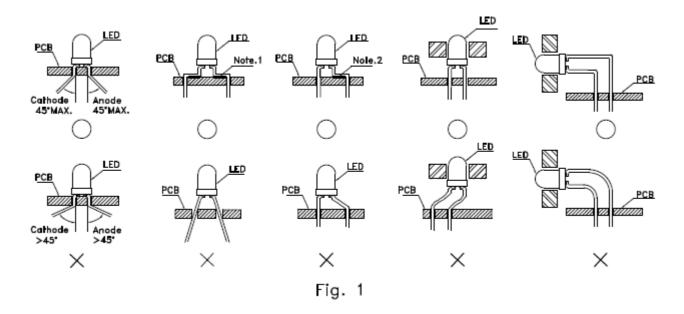
| Part No. | LG-355PT2C94F-928 | Page | 6 of 9 |
|----------|-------------------|------|--------|
|----------|-------------------|------|--------|





LED MOUNTING METHOD

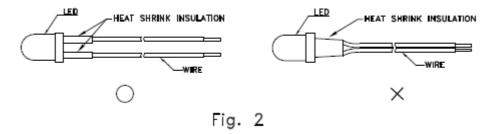
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures (Fig.1).



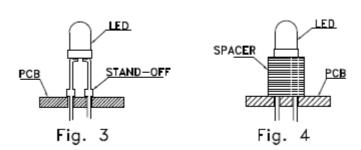
" " Correct mounting method "x" Incorrect mounting method

Note 1-2: Do not route PCB trace in the contact area between the lead frame and the PCB to prevent short-circuits.

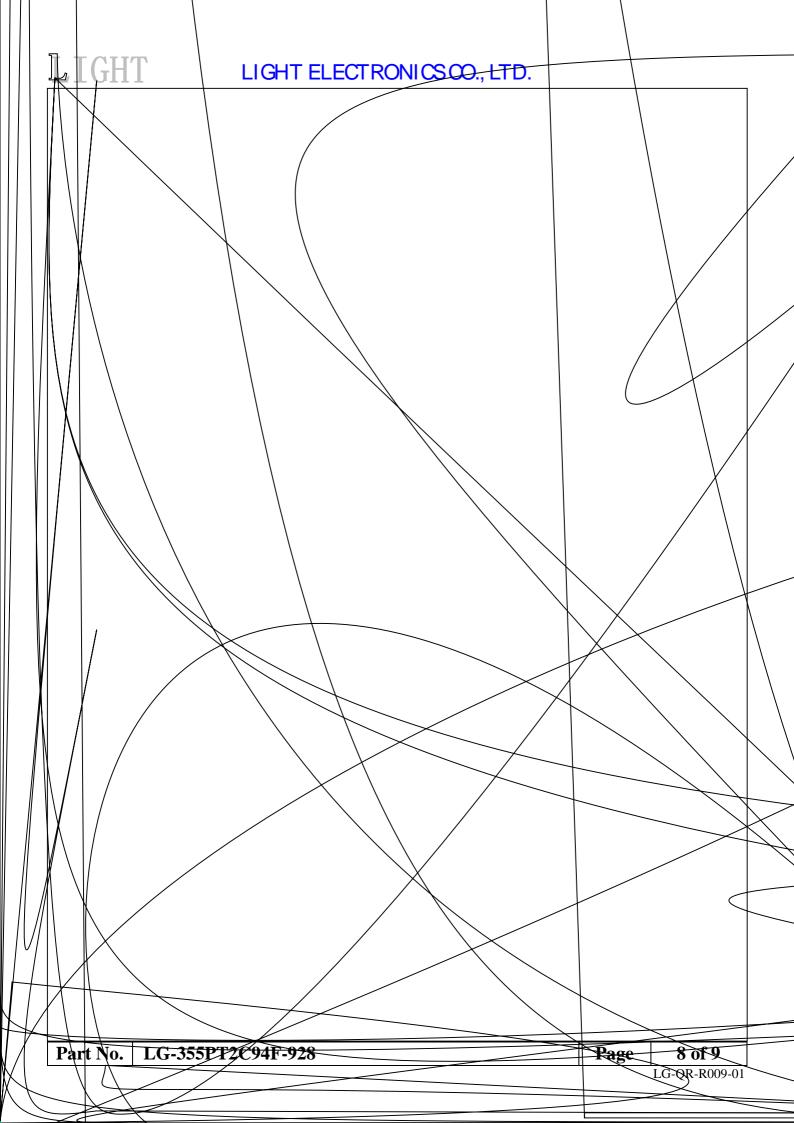
2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit (Fig.2).



3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



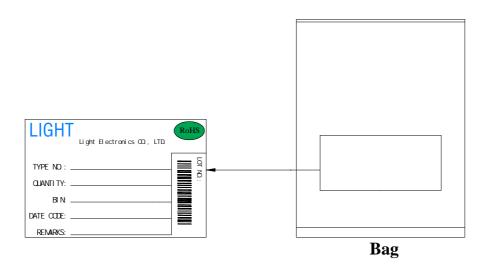
| Part No. LG-355PT2C94F-928 Page 7 of 9 |
|---|
| Dort No. I C 255DT2C04E 029 Dogo 7 of 0 |

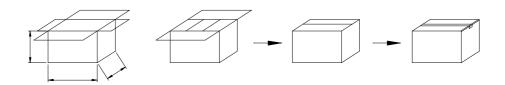


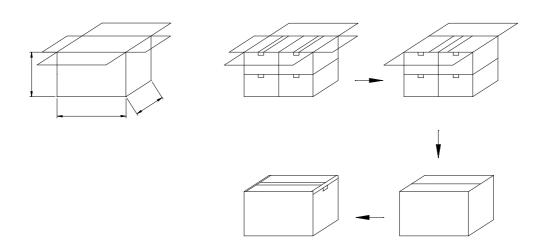




PACKAGE







| Bag minimum volume | Bag volume | Inner box volume | Outer carton volume |
|--------------------|-------------|------------------|---------------------|
| (pcs / Bag) | (pcs / Bag) | (Bag / box) | (Box / Carton) |
| 500 | 1000 | 10 | 4 |

| Part No. | LG-355PT2C94F-928 | Page | 9 of 9 |
|----------|-------------------|------|--------|
|----------|-------------------|------|--------|